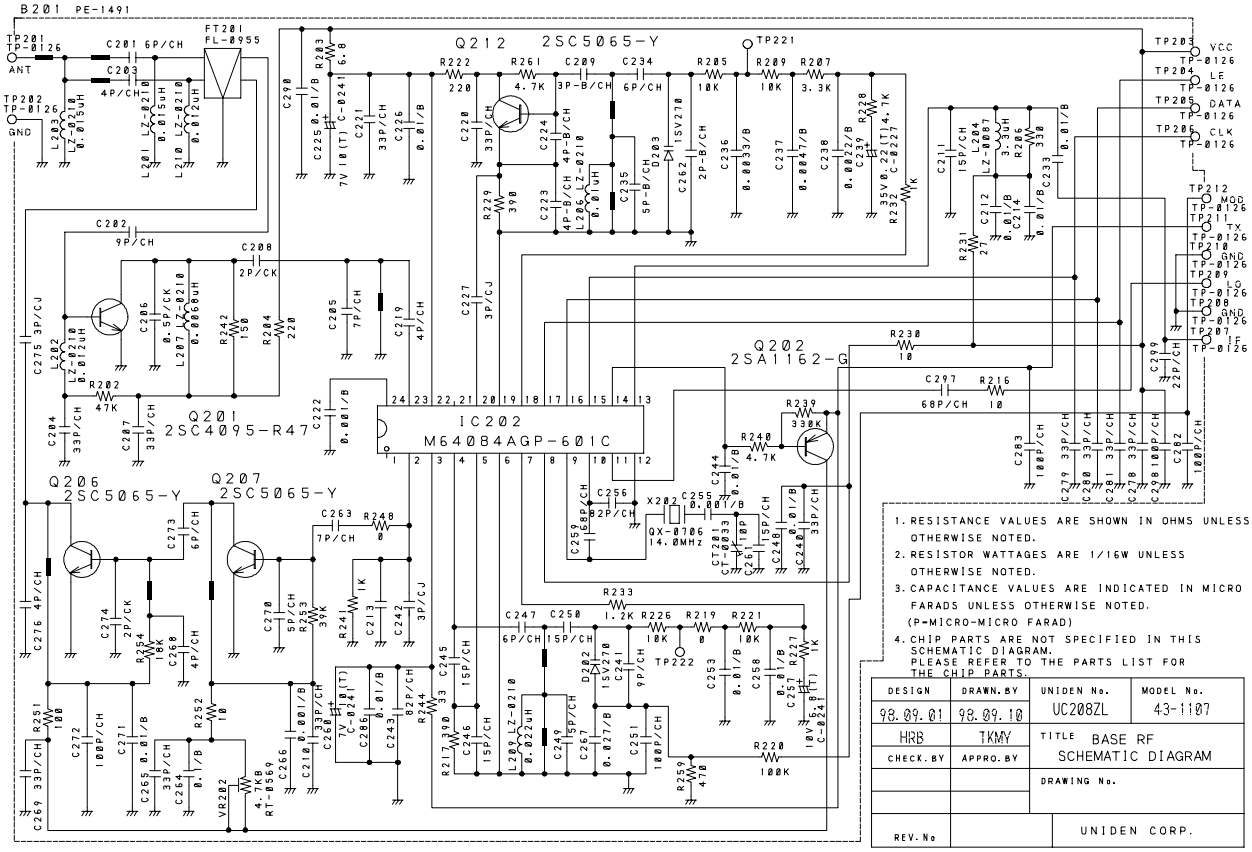
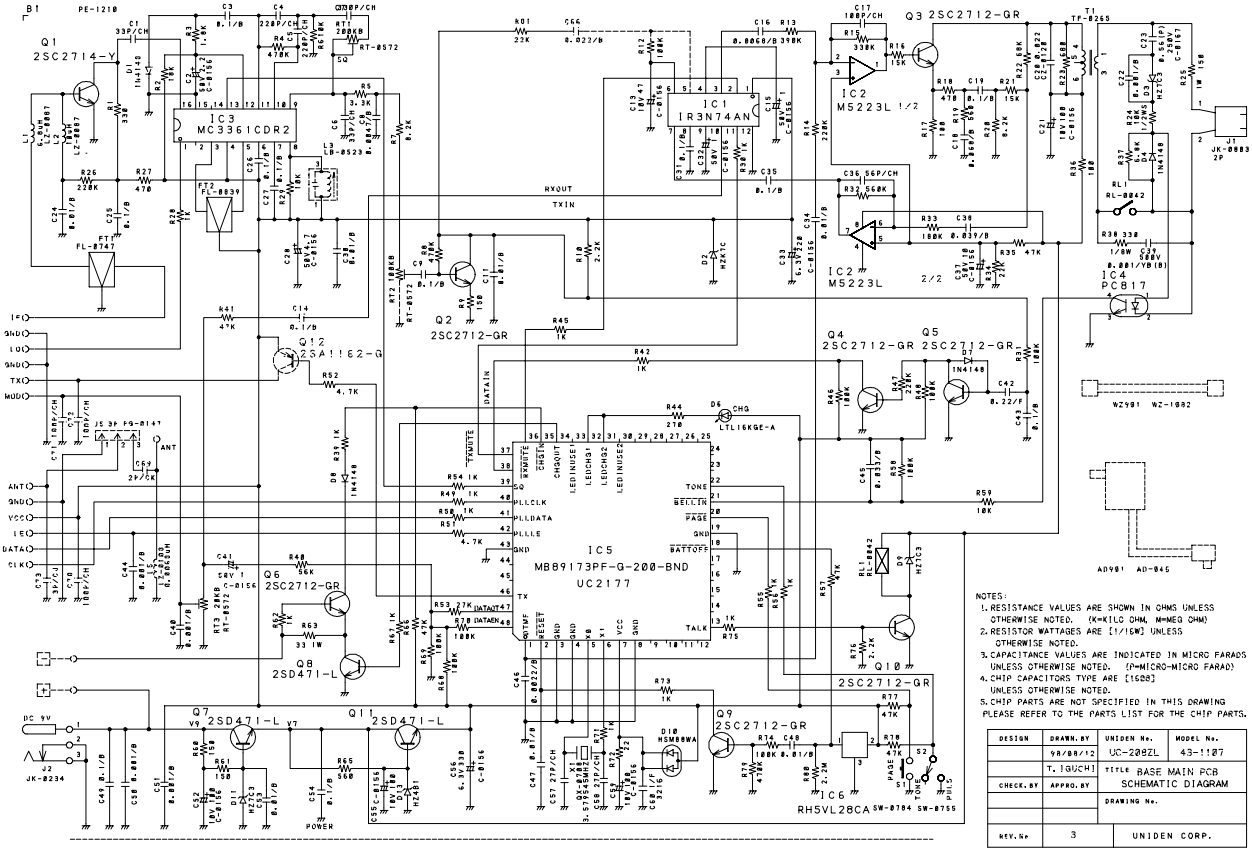

B201 PE-1491
Q212 2SC5065-Y
Q202 2SA1162-G
Q201 2SC4095-R47
IC202 M64084AGP-601C
Q206 2SC5065-Y
Q207 2SC5065-Y
X202 QX-0706 14.8MHz
1. RESISTANCE VALUES ARE SHOWN IN OHMS UNLESS OTHERWISE NOTED.
2. RESISTOR WATTAGES ARE 1/16W UNLESS OTHERWISE NOTED.
3. CAPACITANCE VALUES ARE INDICATED IN MICRO FARADS UNLESS OTHERWISE NOTED. (P=MICRO-MICRO FARAD)
4. CHIP PARTS ARE NOT SPECIFIED IN THIS SCHEMATIC DIAGRAM. PLEASE REFER TO THE PARTS LIST FOR THE CHIP PARTS.
DESIGN 98.09.01 | DRAWN.BY 98.09.10 | UNIDEN No. UC208ZL | MODEL No. 43-1107
CHECK.BY HRB | APPRO.BY TKMY | TITLE BASE RF SCHEMATIC DIAGRAM
DRAWING No.
REV.No | UNIDEN CORP.


B1 PE-1210
Q1 2SC2714-Y
IC3 MC3361CDR2
IC1 IR3N74AN
IC2 M5223L 1/2
IC2 M5223L 2/2
Q3 2SC2712-GR
IC4 PC817
Q2 2SC2712-GR
Q12 2SA1162-G
Q4 2SC2712-GR
Q5 2SC2712-GR
IC5 MB89173PF-G-200-BND UC2177
Q6 2SC2712-GR
Q8 2SD471-L
Q7 2SD471-L
Q11 2SD471-L
Q10 2SC2712-GR
Q9 2SC2712-GR
IC6 RH5VL28CA
RXOUT
TXIN
DATAIN
DATAOUT
NOTES:
1. RESISTANCE VALUES ARE SHOWN IN OHMS UNLESS OTHERWISE NOTED. (K=KILO OHM, M=MEG OHM)
2. RESISTOR WATTAGES ARE [1/16W] UNLESS OTHERWISE NOTED.
3. CAPACITANCE VALUES ARE INDICATED IN MICRO FARADS UNLESS OTHERWISE NOTED. (P=MICRO-MICRO FARAD)
4. CHIP CAPACITORS TYPE ARE [1608] UNLESS OTHERWISE NOTED.
5. CHIP PARTS ARE NOT SPECIFIED IN THIS DRAWING PLEASE REFER TO THE PARTS LIST FOR THE CHIP PARTS.
DESIGN | DRAWN.BY 98/08/12 | UNIDEN No. UC-208ZL | MODEL No. 43-1107
T. IGUCHI | TITLE BASE MAIN PCB SCHEMATIC DIAGRAM
CHECK.BY | APPRO.BY
DRAWING No.
REV.No 3 | UNIDEN CORP.